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Sun Microsystems, Inc.
Palo Alto, California, 94303

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Execution Date December 14, 2000

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A. Patent Application No.(s):

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5. Name and address of party to whom correspondence concerning document should be mailed:

DAVID W. VICTOR, ESQ.
KONRAD RAYNES & VICTOR LLP
1180 S. Beverly Drive, Suite 501
Los Angeles, CA 90035

6. Total number of applications and patents involved: [1]

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PATENT
REEL: 011412 FRAME: 0972

ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

(1) William H. Connor
County of Boulder

of Boulder
and State of Colorado

have invented certain improvement in

TITLE

METHOD, SYSTEM, AND PROGRAM FOR MANAGING THE RATE AT WHICH CLIENT REQUESTS
FOR A SERVICE ARE TRANSMITTED

DATES THAT
INVENTORS
SIGNED THE
DECLARATION

and executed, respectively, a United States patent application therefore on
(1) 12/14, 2000

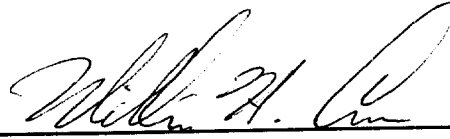
Whereas, SUN MICROSYSTEMS, INC., a corporation of Delaware, having a place of business at Palo Alto, California, 94303, (hereinafter called SUN), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to SUN, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to SUN, its successors and assigns; and I hereby agree that SUN may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by SUN.

Signed and sealed

CITY
DATE

(1) at Boulder, CO
on 12/14, 2000,



William H. Connor

SIGNATURE
INVENTOR